

# Quad 2-Input OR Gate MM74HCT32

#### **General Description**

The MM74HCT32 is a logic function fabricated by using advanced silicon–gate CMOS technology, which provides the inherent benefits of CMOS — low quiescent power and wide power supply range. This device is input and output characteristic and pin–out compatible with standard 74LS logic families. All inputs are protected from static discharge damage by internal diodes to  $V_{\rm CC}$  and ground.

MM74HCT devices are intended to interface between TTL and NMOS components and standard CMOS devices. These parts are also plug—in replacements for LS—TTL devices and can be used to reduce power consumption in existing designs.

#### **Features**

- TTL, LS Pin-out and Threshold Compatible
- Fast Switching: t<sub>PLH</sub>, t<sub>PHL</sub>= 10 ns (Typ.)
- Low Power: 10 μW at DC
- High Fan-out, 10 LS-TTL Loads
- These Devices are Pb-Free, Halide Free and are RoHS Compliant

#### **Connection Diagram**

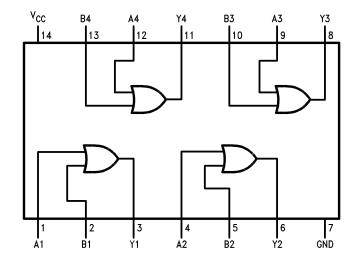


Figure 1. Pin Assignments for SOIC and TSSOP

#### **Logic Diagram**

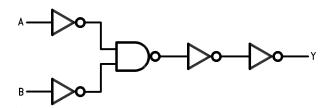
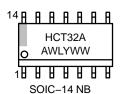


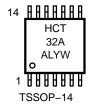
Figure 2. Logic Diagram





#### MARKING DIAGRAM





HCT32A = Specific Device Code A = Assembly Location WL, L = Wafer Lot

Y = Year
WW, W = Work Week

#### ORDERING INFORMATION

See detailed ordering and shipping information on page 3 of this data sheet.

#### MM74HCT32

#### ABSOLUTE MAXIMUM RATINGS (Note 1)

Symbol		Parameter	Rating
V <sub>CC</sub>	Supply Voltage		−0.5 to +7.0 V
V <sub>IN</sub>	DC Input Voltage		–0.5 to V <sub>CC</sub> + 0.5 V
V <sub>OUT</sub>	DC Output Voltage		–0.5 to V <sub>CC</sub> + 0.5 V
I <sub>IK</sub> , I <sub>OK</sub>	Clamp Diode Current		±20 mA
l <sub>OUT</sub>	DC Output Current, per Pin		±25 mA
Icc	DC V <sub>CC</sub> or GND Current, per Pin		±50 mA
T <sub>STG</sub>	Storage Temperature Range		–65°C to +150°C
P <sub>D</sub>	Power Dissipation	S.O. Package Only	500 mW
TL	Lead Temperature (Soldering 10 S	Lead Temperature (Soldering 10 Seconds)	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V <sub>CC</sub>	Supply Voltage	4.5	5.5	V
V <sub>IN</sub> , V <sub>OUT</sub>	DC Input or Output Voltage	0	V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature Range	-40	+85	°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise or Fall Times	-	500	ns

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

#### **DC CHARACTERISTICS** ( $V_{CC} = 5 V \pm 10\%$ (unless otherwise specified))

			T <sub>A</sub> =	= 25°C	$T_A = -40^{\circ}C$ to $85^{\circ}C$	
Symbol	Parameter	Conditions	Тур	Gua	ranteed Limits	Unit
V <sub>IH</sub>	Minimum HIGH Level Input Voltage		-	2.0	2.0	V
V <sub>IL</sub>	Maximum LOW Level Input Voltage		-	0.8	0.8	V
V <sub>OH</sub>	Minimum HIGH Level Output Voltage	$V_{IN} = V_{IH}$ or $V_{IL}$ , $ I_{OUT}  = 20 \mu A$	V <sub>CC</sub>	V <sub>CC</sub> – 0.1	V <sub>CC</sub> – 0.1	V
		$V_{IN} = V_{IH} \text{ or } V_{IL},  I_{OUT}  = 4.0 \text{ mA},$ $V_{CC} = 4.5 \text{ V}$	4.2	3.98	3.84	
		$V_{IN} = V_{IH} \text{ or } V_{IL},  I_{OUT}  = 4.8 \text{ mA},$ $V_{CC} = 5.5 \text{ V}$	5.2	4.98	4.84	
V <sub>OL</sub>	Maximum LOW Level Voltage	$V_{IN} = V_{IH},  I_{OUT}  = 20 \mu A$	0	0.1	0.1	V
		$V_{IN} = V_{IH},  I_{OUT}  = 4.0 \text{ mA}, $ $V_{CC} = 4.5 \text{ V}$	0.2	0.26	0.33	
		$V_{IN} = V_{IH},  I_{OUT}  = 4.8 \text{ mA}, $ $V_{CC} = 5.5 \text{ V}$	0.2	0.26	0.33	
I <sub>IN</sub>	Maximum Input Current	$V_{IN} = V_{CC}$ or GND, $V_{IH}$ or $V_{IL}$	-	±0.1	±1.0	μΑ
I <sub>CC</sub>	Maximum Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0 \mu A$	-	2.0	20	μΑ
		V <sub>IN</sub> = 2.4 V or 0.5 V (Note 2)	-	1.2	1.4	mA

<sup>2.</sup> This is measured per input with all other inputs held at  $\rm V_{CC}$  or ground.

<sup>1.</sup> Unless otherwise specified all voltages are referenced to ground.

#### **MM74HCT32**

### **AC CHARACTERISTICS** ( $V_{CC}$ = 5.0 V, $t_r$ = $t_f$ = 6 ns, $C_L$ = 15 pF, $T_A$ = 25°C (unless otherwise noted))

Symbol	Parameter	Conditions	Тур	Guaranteed Limit	Unit
$t_{PLH},t_{PHL}$	Maximum Propagation Delay		10	-	ns

#### **AC CHARACTERISTICS** ( $V_{CC}$ = 5.0 V ±10%, $t_r$ = $t_f$ = 6 ns, $C_L$ = 15 pF (unless otherwise noted))

			T <sub>A</sub> =	25°C	$T_A = -40^{\circ}C$ to $85^{\circ}C$	
Symbol	Parameter	Conditions	Тур	Gua	ranteed Limits	Unit
t <sub>PLH</sub> , t <sub>PHL</sub>	Maximum Propagation Delay		12	20	25	ns
t <sub>THL</sub> , t <sub>TLH</sub>	Maximum Output Rise & Fall Time		8	15	19	ns
C <sub>PD</sub>	Power Dissipation Capacitance	(Note 3)	48	_	-	pF
C <sub>IN</sub>	Maximum Input Capacitance		5	10	10	pF

<sup>3.</sup>  $C_{PD}$  determines the no load dynamic power consumption,  $P_D = C_{PD} \ V_{CC} 2 \ f + I_{CC} \ V_{CC}$ , and the no load dynamic current consumption,  $I_S = C_{PD} \ V_{CC} f + I_{CC}$ .

#### **ORDERING INFORMATION**

Part Number	Package	Shipping <sup>†</sup>
MM74HCT32M	SOIC-14, Case 751A-03 (Pb-Free, Halide-Free)	55 Units / Tube
MM74HCT32MX	SOIC-14, Case 751A-03 2500 Units / Tape & Reel (Pb-Free, Halide-Free)	
MM74HCT32MTCX	TSSOP-14, Case 948G-01 (Pb-Free, Halide Free)	2500 Units / Tape & Reel

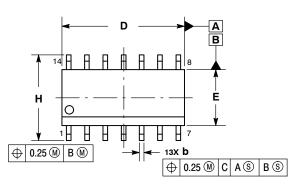
<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

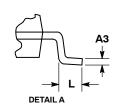


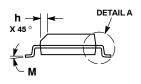


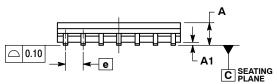
SOIC-14 NB CASE 751A-03 ISSUE L

**DATE 03 FEB 2016** 









## GENERIC MARKING DIAGRAM\*

MIN MAX

0.050 BSC

0.068

0.019

0.054

0.25 0.004 0.010

0.25 0.008 0.010

0.50 0.010 0.019

1.25 0.016 0.049

0.49 0.014

8.55 8.75 0.337 0.344 3.80 4.00 0.150 0.157

NOTES:
1. DIMENSIONING AND TOLERANCING PER

5. MAXIMUM MOLD PROTRUSION 0.15 PER

MILLIMETERS MIN MAX

1.27 BSC

0.19

0.25

0.40

SIDE

Α

A1 0.10

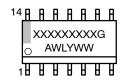
АЗ

**b** 0.35

D 8.55 E 3.80

e H h

ASME Y14.5M, 1994.
CONTROLLING DIMENSION: MILLIMETERS.
DIMENSION b DOES NOT INCLUDE DAMBAR
PROTRUSION. ALLOWABLE PROTRUSION
SHALL BE 0.13 TOTAL IN EXCESS OF AT
MAXIMUM MATERIAL CONDITION.
DIMENSIONS D AND E DO NOT INCLUDE
MOLD PROTRUSIONS.



XXXXX = Specific Device Code A = Assembly Location

WL = Wafer Lot
 Y = Year
 WW = Work Week
 G = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DIMENSIONS: MILLIMETERS

#### **STYLES ON PAGE 2**

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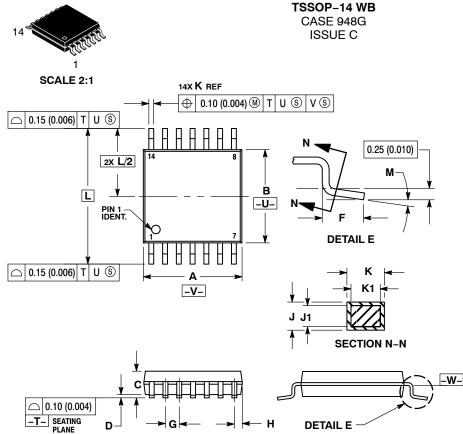
#### SOIC-14 CASE 751A-03 ISSUE L

#### DATE 03 FEB 2016

STYLE 1: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. NO CONNECTION 7. ANODE/CATHODE 8. ANODE/CATHODE 9. ANODE/CATHODE 10. NO CONNECTION 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 2: CANCELLED	STYLE 3: PIN 1. NO CONNECTION 2. ANODE 3. ANODE 4. NO CONNECTION 5. ANODE 6. NO CONNECTION 7. ANODE 8. ANODE 9. ANODE 10. NO CONNECTION 11. ANODE 12. ANODE 13. NO CONNECTION 14. COMMON CATHODE	STYLE 4: PIN 1. NO CONNECTION 2. CATHODE 3. CATHODE 4. NO CONNECTION 5. CATHODE 6. NO CONNECTION 7. CATHODE 8. CATHODE 9. CATHODE 10. NO CONNECTION 11. CATHODE 12. CATHODE 13. NO CONNECTION 14. COMMON ANODE
STYLE 5: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. NO CONNECTION 7. COMMON ANODE 8. COMMON CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 6: PIN 1. CATHODE 2. CATHODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE 7. CATHODE 8. ANODE 9. ANODE 10. ANODE 11. ANODE 12. ANODE 13. ANODE 14. ANODE	STYLE 7: PIN 1. ANODE/CATHODE 2. COMMON ANODE 3. COMMON CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. ANODE/CATHODE 7. ANODE/CATHODE 8. ANODE/CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. COMMON CATHODE 12. COMMON ANODE 13. ANODE/CATHODE 14. ANODE/CATHODE	STYLE 8: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. ANODE/CATHODE 7. COMMON ANODE 8. COMMON ANODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. NO CONNECTION 12. ANODE/CATHODE 13. ANODE/CATHODE 14. COMMON CATHODE

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**DATE 17 FEB 2016** 

- NOTES.

  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

  2. CONTROLLING DIMENSION: MILLIMETER.

  3. DIMENSION A DOES NOT INCLUDE MOLD
- FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
  DIMENSION B DOES NOT INCLUDE
- INTERLEAD FLASH OR PROTRUSION.
  INTERLEAD FLASH OR PROTRUSION SHALL
- INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.

  5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.

  6. TERMINAL NUMBERS ARE SHOWN FOR DEFERENCE ONLY
- REFERENCE ONLY.
  DIMENSION A AND B ARE TO BE
- DETERMINED AT DATUM PLANE -W-.

	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	4.90	5.10	0.193	0.200
В	4.30	4.50	0.169	0.177
С		1.20		0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65	BSC	0.026 BSC	
Н	0.50	0.60	0.020	0.024
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40	6.40 BSC 0.252 BSC		BSC
М	o°	8 °	0 °	8 °

#### **GENERIC MARKING DIAGRAM\***



= Assembly Location

= Wafer Lot V = Year

W = Work Week

= Pb-Free Package (Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

SOLDERIN	G FOOTPRINT
-	7.06
1	
— <u>—</u>	
, <u></u>	PITCH
14X 0.36	<del></del>
1.26	DIMENSIONS: MILLIMETERS

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